

US00D504335S

(12) **United States Design Patent** (10) **Patent No.:** **US D504,335 S**  
**Stevenson et al.** (45) **Date of Patent:** **\*\* Apr. 26, 2005**

(54) **SENSOR HOUSING** 6,637,933 B1 \* 10/2003 Liao ..... 374/170  
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(\*\*) Term: **14 Years**

(21) Appl. No.: **29/197,111**

(22) Filed: **Jan. 9, 2004**

(51) **LOC (7) Cl.** ..... **10-04**

(52) **U.S. Cl.** ..... **D10/57**

(58) **Field of Search** ..... D10/57, 60; 374/209, 374/208, 170, 155, 142, 141, 183

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(57) **CLAIM**

The ornamental design for a sensor housing, as shown and described.

**DESCRIPTION**

FIG. 1 is a top, front and right side perspective view of a temperature and humidity sensor housing in accordance with our new design;

FIG. 2 is a front elevation view of the temperature and humidity sensor housing shown in FIG. 1;

FIG. 3 is a top plan view of the temperature and humidity sensor housing shown in FIG. 1;

FIG. 4 is a bottom plan view of the temperature and humidity sensor housing shown in FIG. 1;

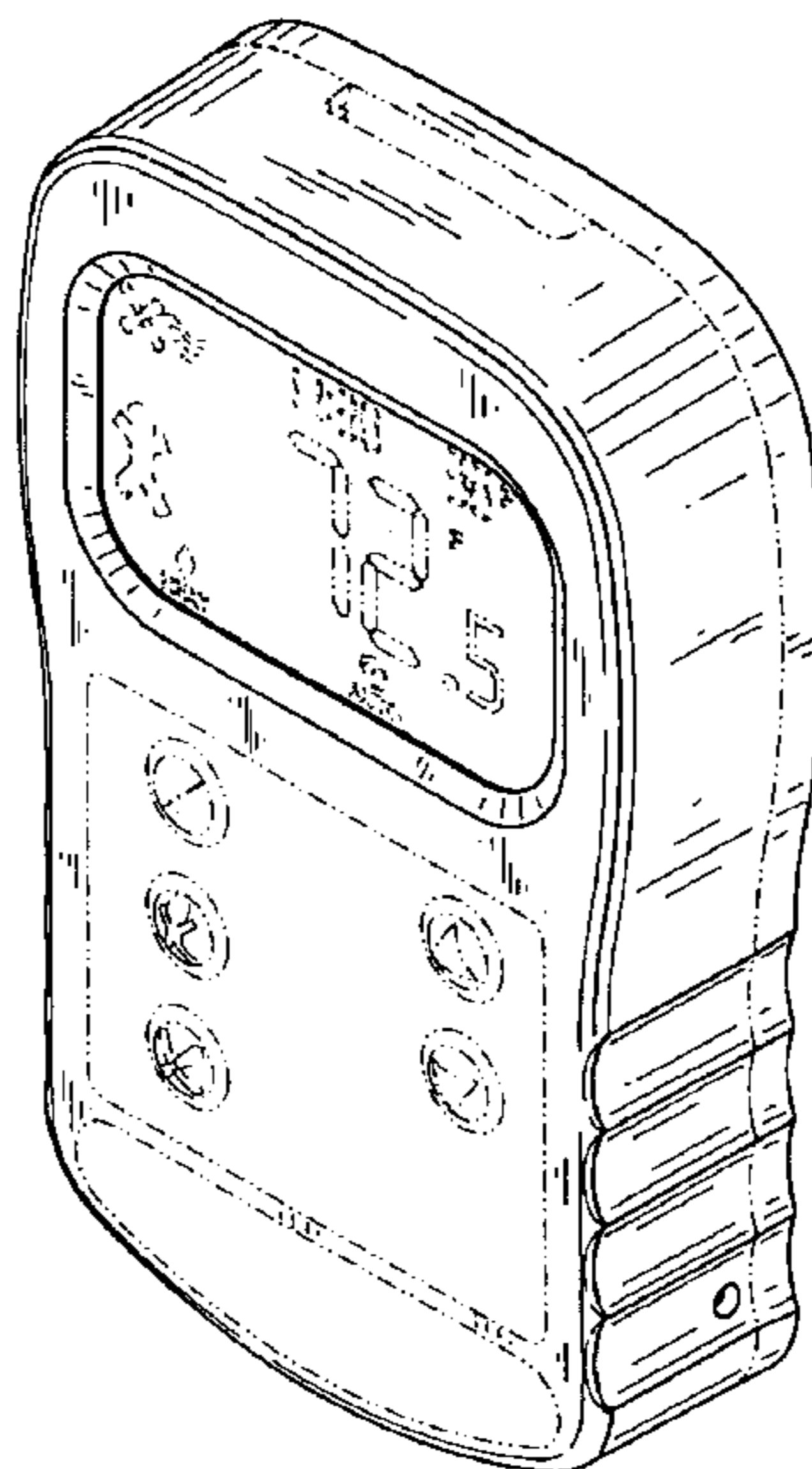
FIG. 5 is a right side elevation view of the temperature and humidity sensor housing shown in FIG. 1; and,

FIG. 6 is a left side elevation view of the temperature and humidity sensor housing shown in FIG. 1.

The rear of the sensor housing does not comprise any portion of the invention, and hence is not shown in the drawings.

The broken line showings are for illustrative purposes only and form no part of the claimed design.

**1 Claim, 3 Drawing Sheets**



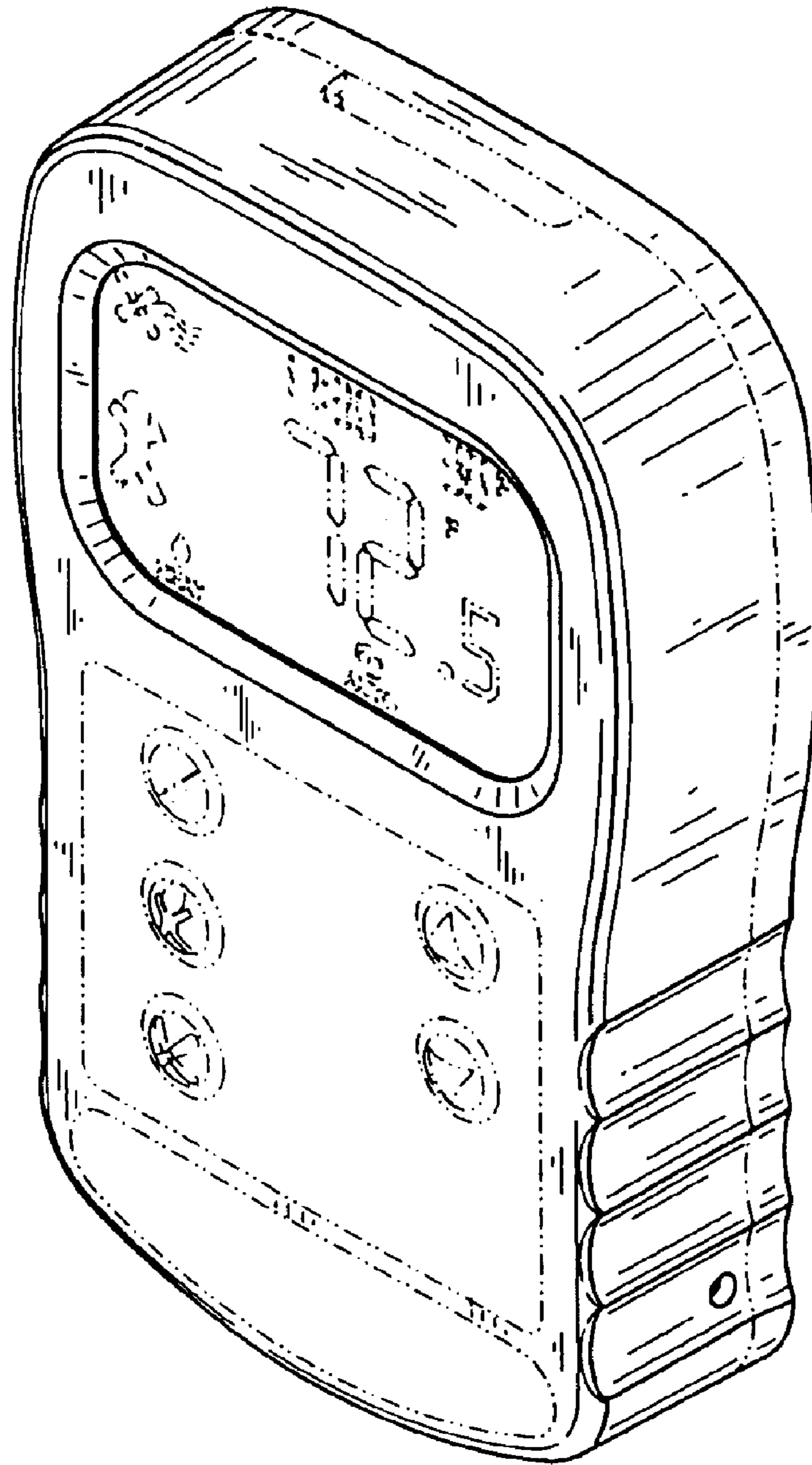


FIG. 1

FIG. 2

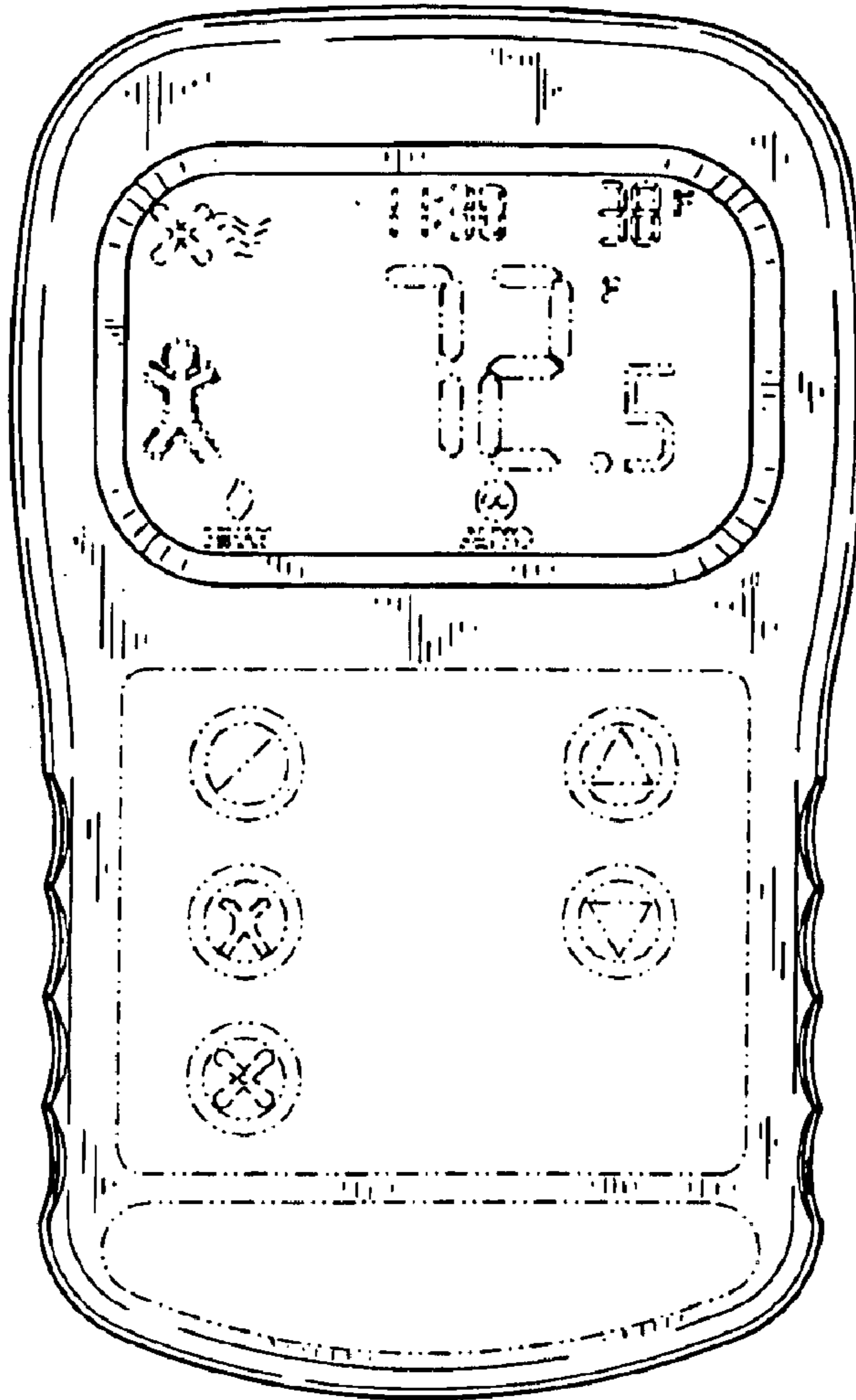


FIG. 3

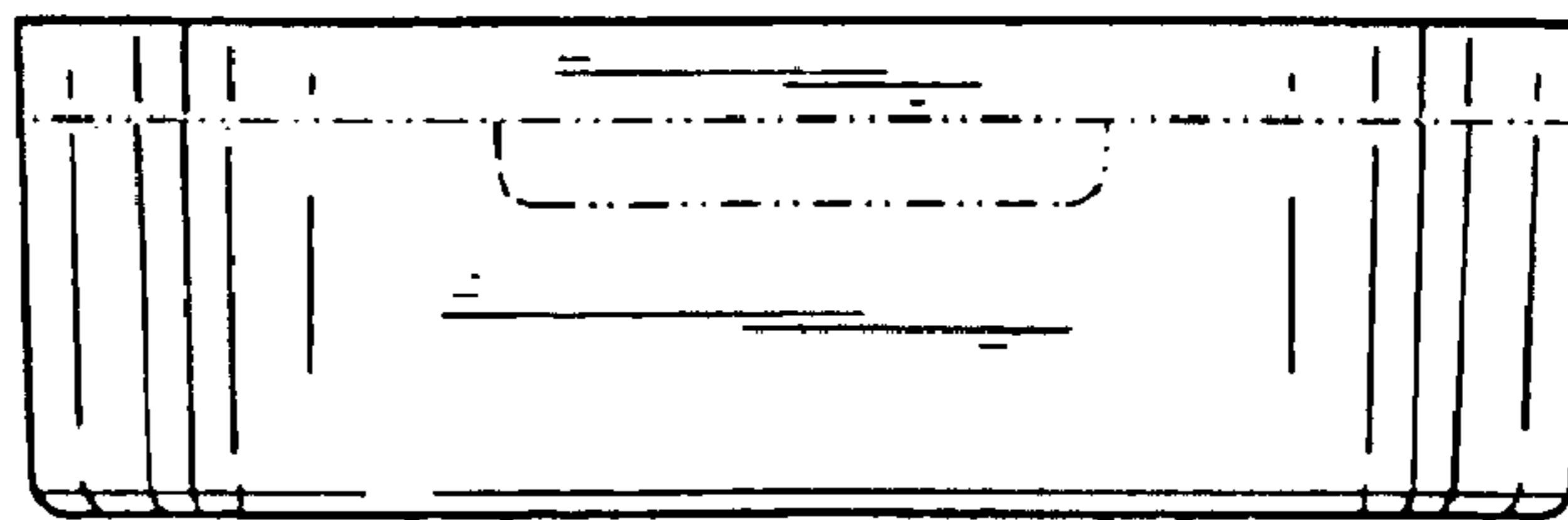
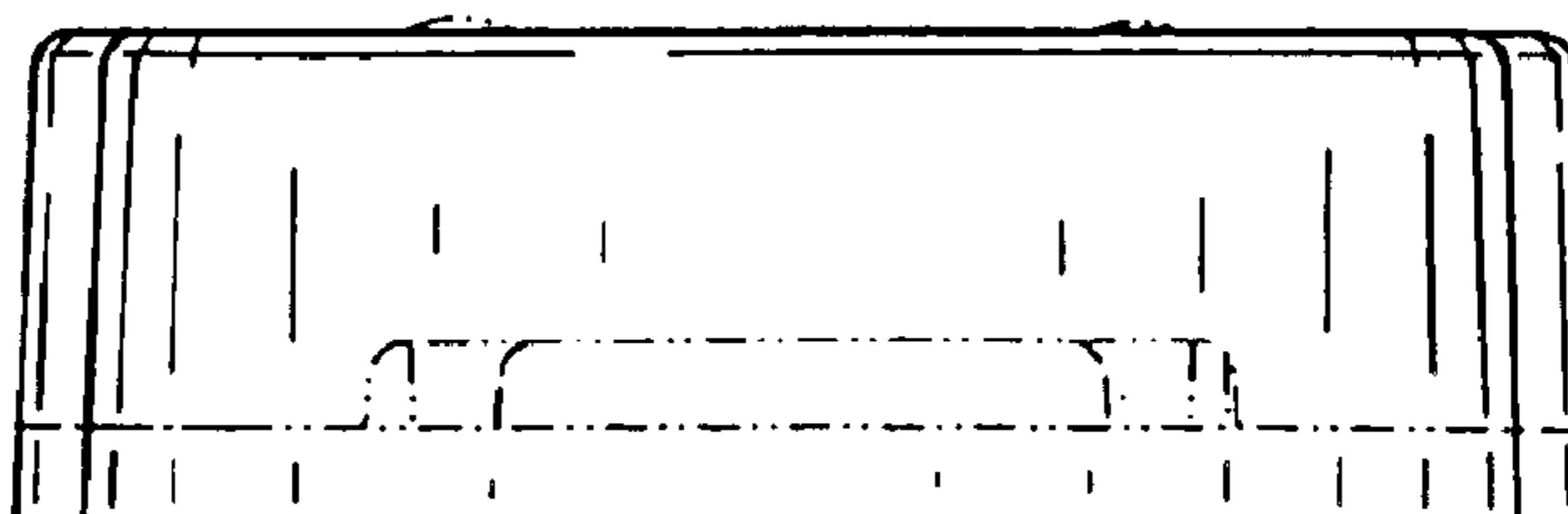


FIG. 4



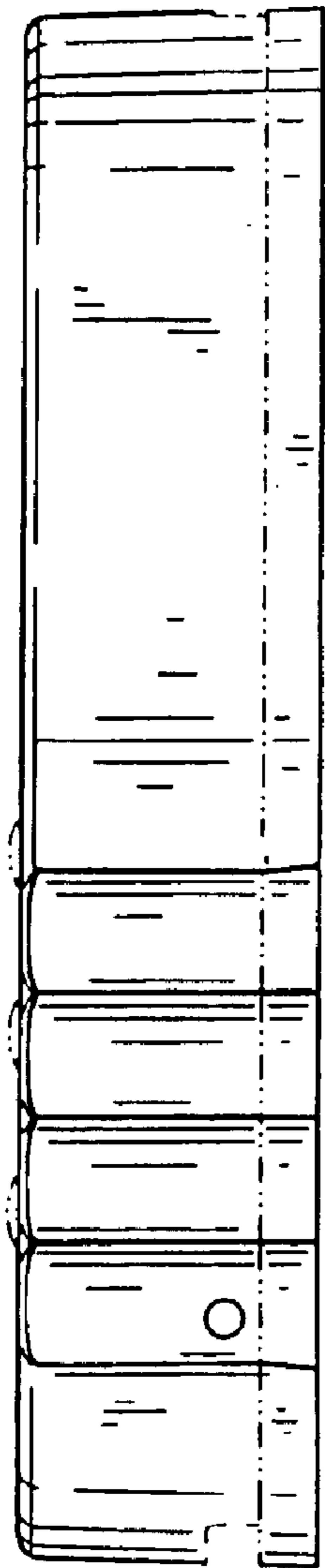


FIG. 5

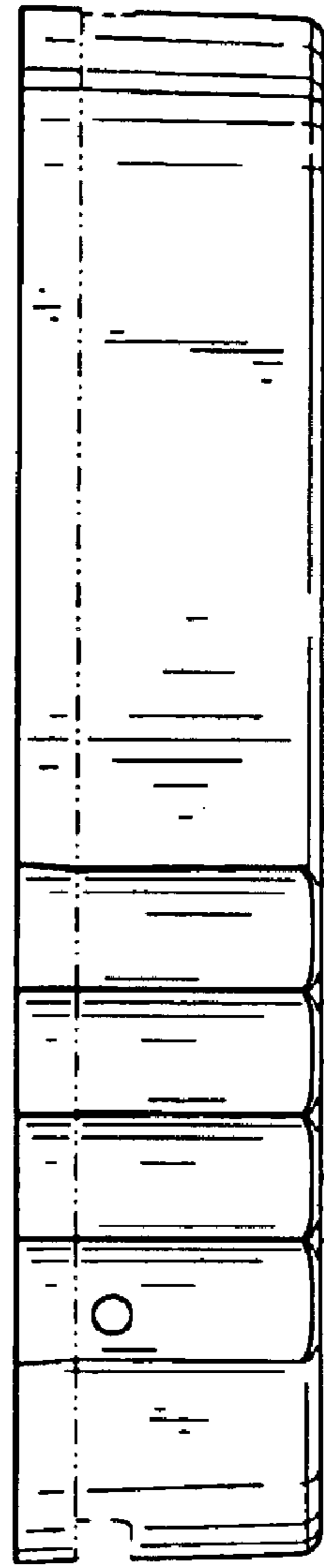


FIG. 6